

# 75LQ150

PD-94190F

## Schottky Rectifier High Efficiency Series Surface Mount (SMD-1) 150V, 75A

### Features

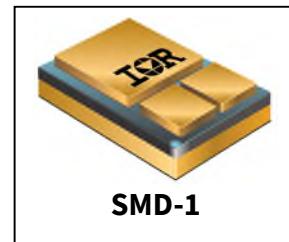
- Hermetically sealed
- Low forward voltage drops
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Surface Mount
- Light weight
- ESD rating: Class NS per MIL-STD-750, Method 1020

### Product Summary

- $V_{RRM}$ : 150V
- $I_{F(AV)}$ : 75A
- $V_F @ 75Apk, T_J = 125^\circ\text{C}$ : 0.78V
- $I_{FSM} @ t_p = 8.3\text{ms half-sine}$ : 700A

### Potential Applications

- DC-DC converter
- Protection circuits
- Motor drives



### Product Validation

Fully qualified according to MIL-PRF-19500 for space applications

### Description

The 75LQ150 Schottky rectifier has been expressly designed to meet the rigorous requirements of IR HiRel environments. It is packaged in the hermetic surface mount SMD-1 ceramic package. The device's forward voltage drop and reverse leakage current are optimized for the lowest power loss and the highest circuit efficiency for typical high frequency switching power supplies and resonant power converters. Full MIL-PRF-19500 quality conformance testing is available on source control drawings to TX, TXV and S quality levels.

### Ordering Information

Table 1 Ordering options

Part number	Package	Screening Level
75LQ150	SMD-1	COTS
75LQ150SCS	SMD-1	JANS

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**Absolute Maximum Ratings****1 Absolute Maximum Ratings****Table 2 Absolute Maximum Ratings**

<b>Symbol</b>	<b>Parameter</b>	<b>Value</b>	<b>Unit</b>
$V_R$	DC reverse voltage	150	V
$V_{RWM}$	Working peak reverse voltage	150	V
$I_{F(AV)}$	Max. average forward current - Refer to Fig. 5 <sup>1</sup>	75	A
$I_{FSM}$	Max. peak one cycle non-repetitive surge current <sup>2</sup>	700	A
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-65 to 150	°C
	Weight	2.6 (Typical)	g

<sup>1</sup> 50% duty cycle @  $T_c = 95^\circ\text{C}$ , square waveform<sup>2</sup>  $t_p = 8.3 \text{ ms}$  half-sine

**Device Characteristics****2 Device Characteristics****2.1 Electrical Characteristics****Table 3 Electrical Characteristics**

<b>Symbol</b>	<b>Parameter</b>	<b>Max.</b>	<b>Unit</b>	<b>Test Conditions</b>
$V_F$	Forward Voltage Drop (Per Leg) See Fig. 1 <sup>1</sup>	1.18	V	@ 75A
		1.45	V	@ 150A
		1.06	V	@ 75A
		1.44	V	@ 150A
		0.78	V	@ 75A
		0.96	V	@ 150A
$I_R$	Reverse Leakage Current (Per Leg) See Fig. 2 <sup>1</sup>	0.2	mA	$T_J = 25^\circ\text{C}$
		36	mA	$T_J = 125^\circ\text{C}$
$C_J$	Junction Capacitance (Per Leg)	1600	pF	$V_R = 5V_{\text{DC}}$ (1MHz, 25°C)
$L_S$	Series Inductance (Per Leg)	5.9 (Typical)	nH	Measured from center of cathode pad to center of anode pad

**2.2 Thermal-Mechanical Specifications****Table 4 Thermal-Mechanical Specifications**

<b>Symbol</b>	<b>Parameter</b>	<b>Max.</b>	<b>Unit</b>	<b>Test Conditions</b>
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.75	°C/W	DC operation See Fig. 4
	Die Size (Typical)	158 x 158	mils	

<sup>1</sup> Pulse Width < 300μs, Duty Cycle < 2%

## Electrical Characteristics Curves

## 3 Electrical Characteristics Curves

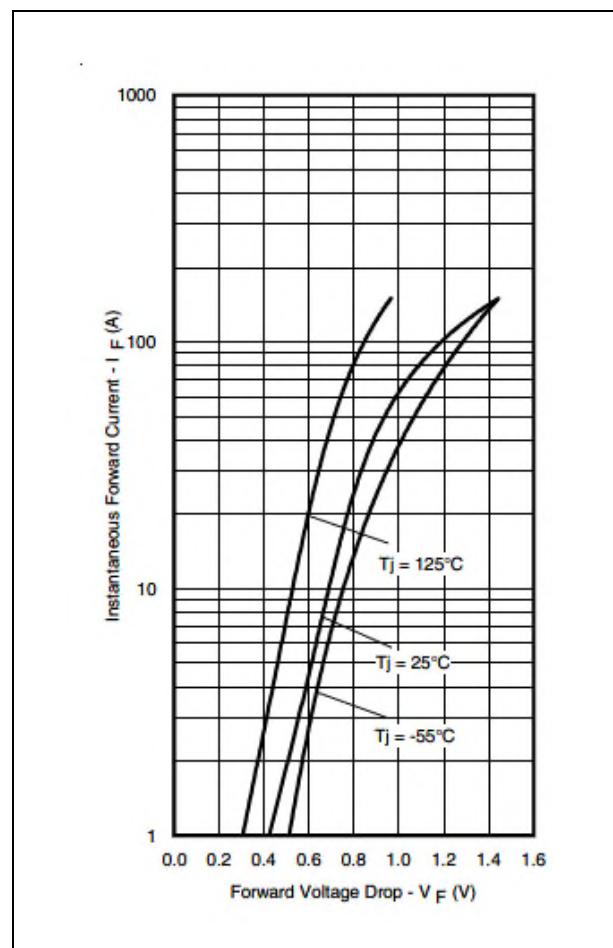


Figure 1 Maximum Forward Voltage Drop Characteristics

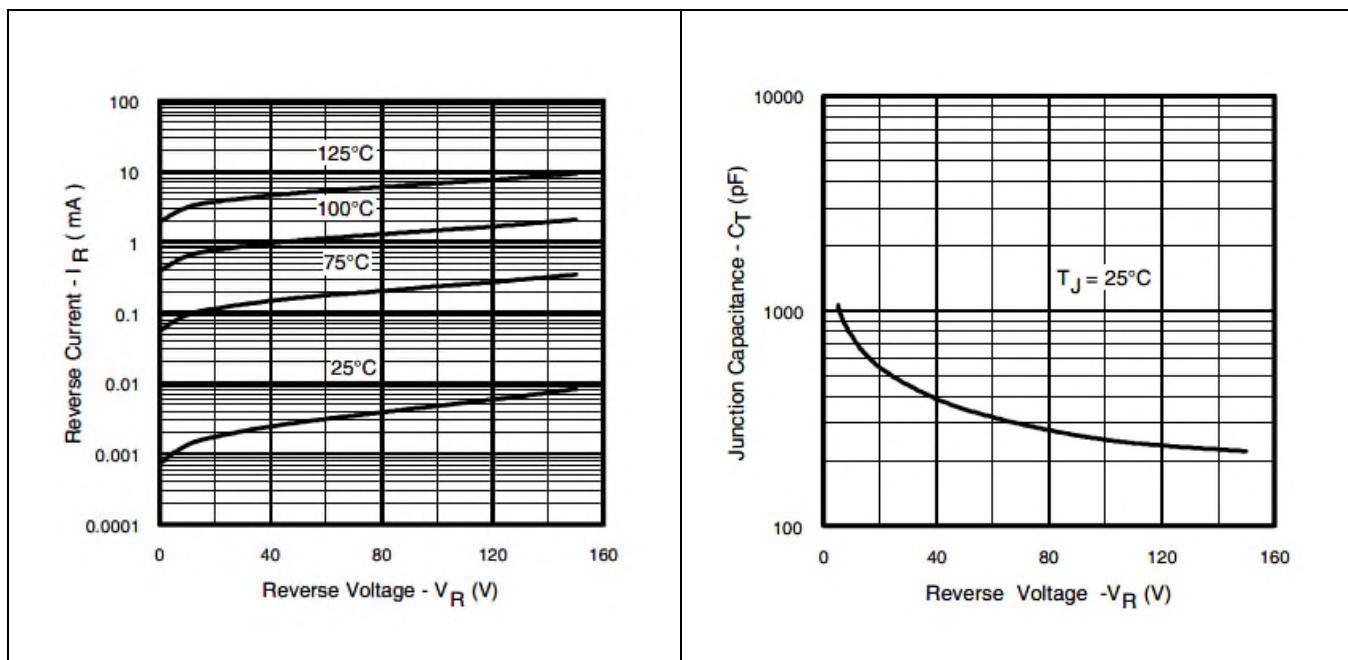


Figure 2 Typical Values of Reverse Current Vs. Reverse Voltage

Figure 3 Typical Junction Capacitance Vs. Reverse Voltage

## Electrical Characteristics Curves

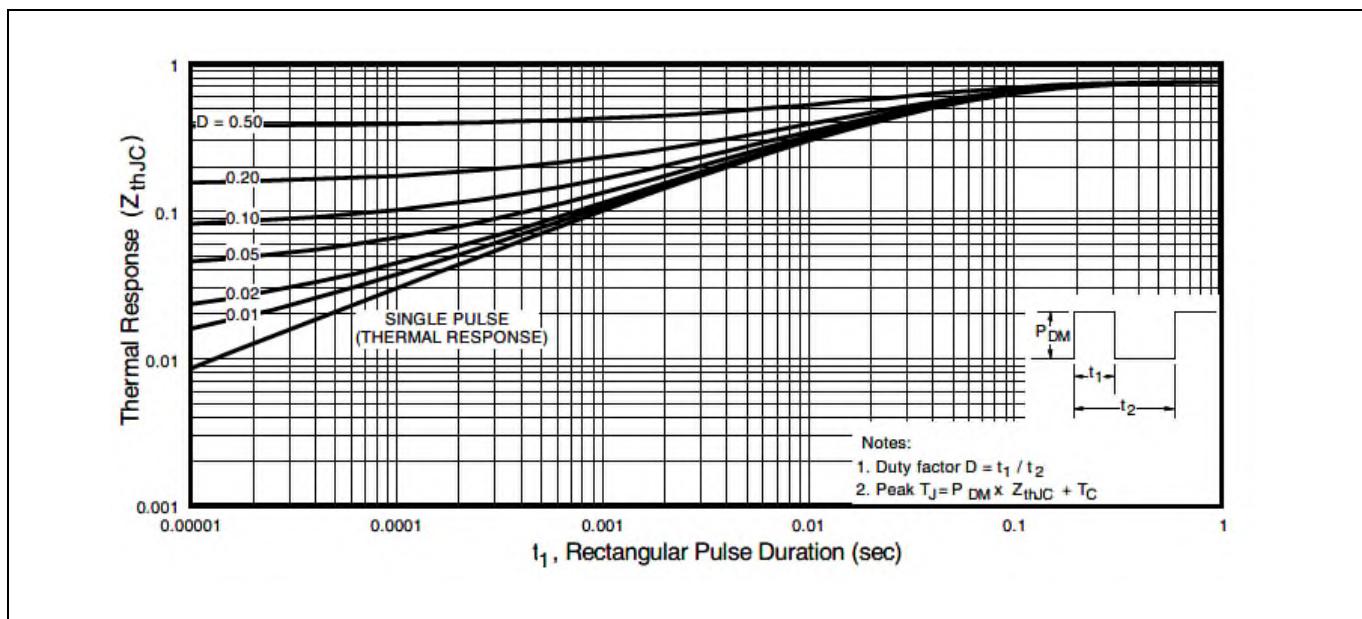
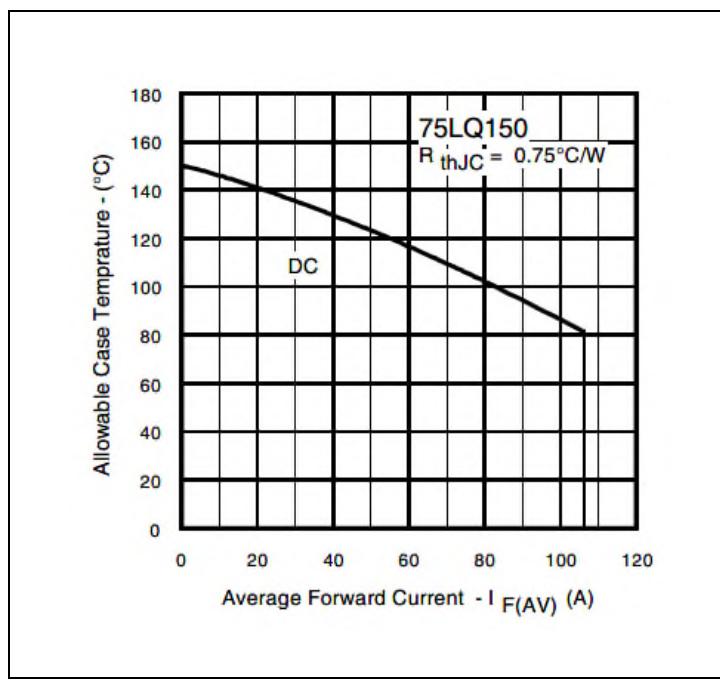
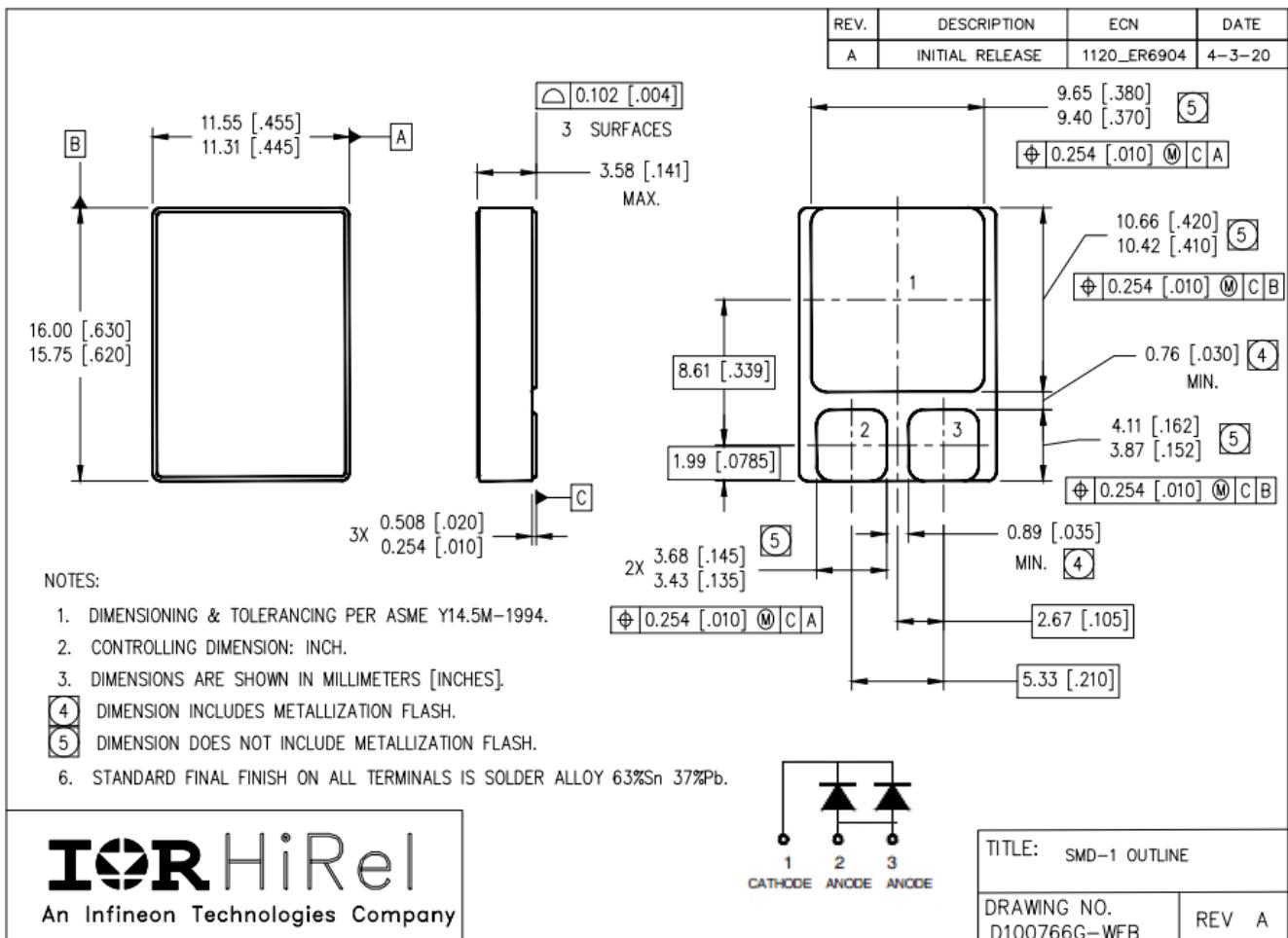
Figure 4 Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

Figure 5 Maximum Allowable Case Temperature Vs. Average Forward Current

## Package Outline

## 4 Package Outline

Note: For the most updated package outline, please see the website: [SMD-1](#)



**Revision history****Revision history**

<b>Document version</b>	<b>Date of release</b>	<b>Description of changes</b>
	05/31/2001	Final datasheet (PD-94190)
Rev A	09/20/2001	Updated Package outline
Rev B	02/27/2002	Updated Pin lay out
Rev C	04/26/2002	Corrected lrm
Rev D	12/12/2005	Updated per ECN-13168
Rev E	07/23/2010	Updated per ECN-17689
Rev F	12/20/2022	Updated per ECN-1120-09314

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